Sensitive Gate Silicon Controlled Rectifiers

Reverse Blocking Thyristors

Designed and tested for repetitive peak operation required for CD ignition, fuel ignitors, flash circuits, motor controls and low-power switching applications.

Features

- Blocking Voltage to 600 V
- High Surge Current 15 A
- Very Low Forward "On" Voltage at High Current
- Low-Cost Surface Mount SOT-223 Package
- These are Pb-Free Devices

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage (Note 1) (R _{GK} = IK, T _J = -40 to +110°C, Sine Wave, 50 to 60 Hz, Gate Open) NYC222 NYC226 NYC228	V _{DRM} , V _{RRM}	50 400 600	V
On-State Current RMS (180° Conduction Angles, T _C = 80°C)	I _{T(RMS)}	1.5	Α
Average On–State Current, (T _C = 65°C, f = 60 Hz, Time = 1 sec)	I _{T(RMS)}	2.0	Α
Peak Non-repetitive Surge Current, @T _A = 25°C, (1/2 Cycle, Sine Wave, 60 Hz)	I _{TSM}	15	Α
Circuit Fusing Considerations (t = 8.3 ms)	I ² t	0.9	A ² s
Forward Peak Gate Power (Pulse Width \leq 1.0 μ sec, T_A = 25°C)	P _{GM}	0.5	V
Forward Average Gate Power (t = 8.3 msec, T _A = 25°C)	P _{G(AV)}	0.1	W
Forward Peak Gate Current (Pulse Width \leq 1.0 μ s, T _A = 25°C)	I _{FGM}	0.2	Α
Reverse Peak Gate Voltage (Pulse Width \leq 1.0 μ s, T _A = 25°C)	V_{RGM}	5.0	>
Operating Junction Temperature Range @ Rated V _{RRM} and V _{DRM}	TJ	-40 to +110	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



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SCRs 1.5 AMPERES RMS 400 thru 600 VOLTS



MARKING DIAGRAM



SOT-223 **CASE 318E** STYLE 11



= Assembly Location = Year

W = Work Week

= Specific Device Code

x = 2, 6 or 8

= Pb-Free Package

(Note: Microdot may be in either location)

PIN ASSIGNMENT				
1	K (Cathode)			
2	A (Anode)			
3	G (Gate)			
4	A (Anode)			
•				

ORDERING INFORMATION

Device	Package	Shipping
NYC222STT1G	SOT-223 (Pb-Free)	1000 /Tape & Reel
NYC226STT1G	SOT-223 (Pb-Free)	1000 /Tape & Reel
NYC228STT1G	SOT-223 (Pb-Free)	1000 /Tape & Reel

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient PCB Mounted	$R_{ heta JA}$	156	°C/W
Thermal Resistance, Junction-to-Tab Measured on MT2 Tab Adjacent to Epoxy	$R_{ heta JT}$	25	°C/W
Maximum Device Temperature for Soldering Purposes for 10 Secs Maximum	T _L	260	°C

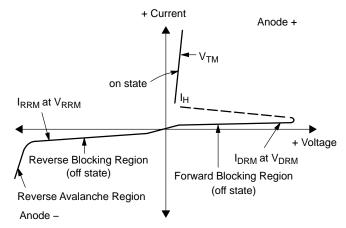
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit			
OFF CHARACTERISTICS								
Peak Repetitive Forward or Reverse Blocking Current $(V_{AK} = Rated V_{DRM}/V_{RRM}; R_{GK} = 1000 \Omega)$	T _C = 25°C T _C = 110°C	I _{DRM} , I _{RRM}	_ _	- -	10 200	μΑ μΑ		
ON CHARACTERISTICS		•	•	•	•			
Peak Forward On–State Voltage (Note 2) (I _{TM} = 2.2 A Peak)		V _{TM}	-	1.2	1.7	V		
Gate Trigger Current (dc) (Note 3) $(V_{AK} = 7 \text{ Vdc}, R_L = 100 \Omega)$	$T_C = 25$ °C $T_C = -40$ °C	I _{GT}		30 -	200 500	μΑ		
Gate Trigger Voltage (dc) (Note 3) $(V_{AK} = 7 \text{ Vdc}, R_L = 100 \Omega)$	$T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$	V _{GT}	- -	- -	0.8 1.2	V		
Gate Non-Trigger Voltage $(V_{AK} = V_{DRM}, R_L = 100 \Omega)$	T _C = 110°C	V _{GD}	0.1	-	-	V		
Holding Current $(V_{AK} = 12 \text{ V}, R_{GK} = 1000 \Omega)$ Initiating Current = 200 mA	T _C = 25°C T _C = -40°C	I _H	<u>-</u>	2.0	5.0 10	mA		
DYNAMIC CHARACTERISTICS		-	•	•	•			
Critical Rate of Rise of Off–State Voltage (T _C = 110°C)		dv/dt	_	25	_	V/μs		
Critical Rate of Rise of On–State Current $(T_C = 110^{\circ}C, I_G = 2 \times I_{GT}, R_{GK} = 1 \text{ k}\Omega)$		di/dt	-	20	-	A/μs		

^{2.} Pulse Width = 1.0 ms, Duty Cycle ≤ 1%.

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Off State Forward Voltage
I _{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Off State Reverse Voltage
I _{RRM}	Peak Reverse Blocking Current
V_{TM}	Peak on State Voltage
I _H	Holding Current



^{3.} R_{GK} Current not included in measurement.

CURRENT DERATING

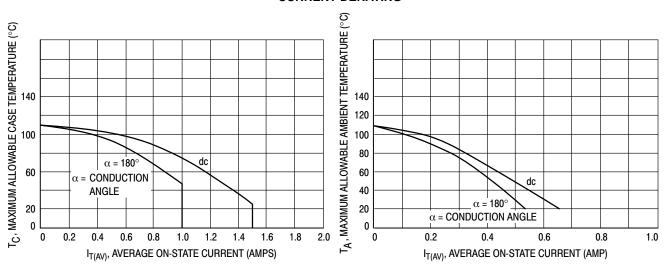


Figure 1. Maximum Case Temperature

Figure 2. Maximum Ambient Temperature

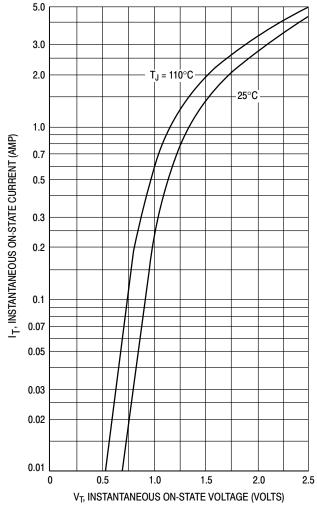


Figure 3. Typical Forward Voltage

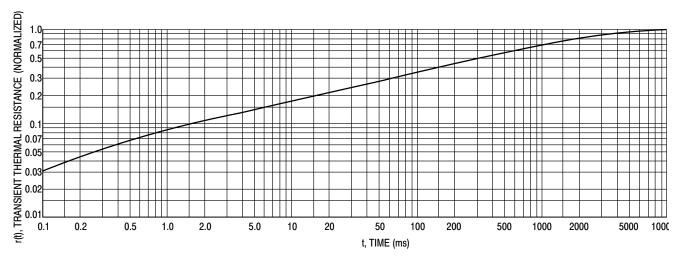


Figure 4. Thermal Response

TYPICAL CHARACTERISTICS

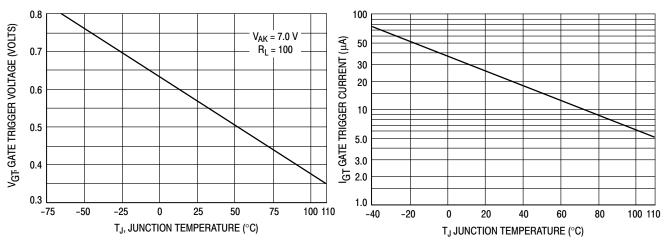


Figure 5. Typical Gate Trigger Voltage

Figure 6. Typical Gate Trigger Current

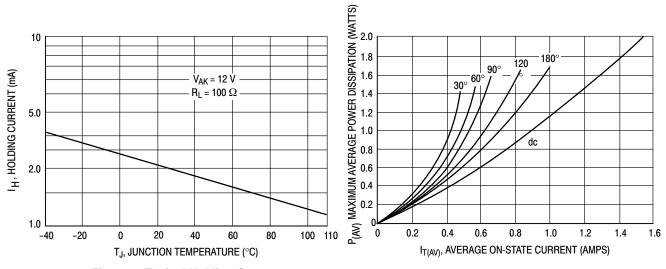
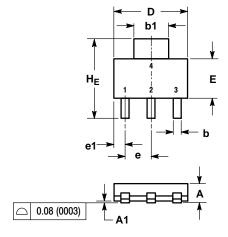


Figure 7. Typical Holding Current

Figure 8. Power Dissipation

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 **ISSUE N**



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.50	1.63	1.75	0.060	0.064	0.068	
A1	0.02	0.06	0.10	0.001	0.002	0.004	
b	0.60	0.75	0.89	0.024	0.030	0.035	
b1	2.90	3.06	3.20	0.115	0.121	0.126	
С	0.24	0.29	0.35	0.009	0.012	0.014	
D	6.30	6.50	6.70	0.249	0.256	0.263	
E	3.30	3.50	3.70	0.130	0.138	0.145	
е	2.20	2.30	2.40	0.087	0.091	0.094	
e1	0.85	0.94	1.05	0.033	0.037	0.041	
L	0.20			0.008			
L1	1.50	1.75	2.00	0.060	0.069	0.078	
HE	6.70	7.00	7.30	0.264	0.276	0.287	
θ		1			-		

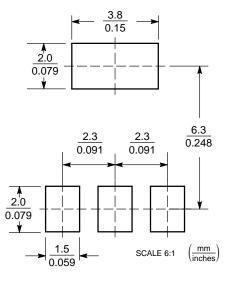
0°



10°

STYLE 11: PIN 1₁₀MT 1 2. MT 2 3. GATE

SOLDERING FOOTPRINT



Littelfuse products are not designed for, and shall not be used for, any purpose (including, without limitation, automotive, military, aerospace, medical, life-saving, life-sustaining or nuclear facility applications, devices intended for surgical implant into the body, or any other application in which the failure or lack of desired operation of the product may result in personal injury, death, or property damage) other than those expressly set forth in applicable Littelfuse product documentation. Warranties granted by Littelfuse shall be deemed void for products used for any purpose not expressly set forth in applicable Littelfuse documentation. Littelfuse shall not be liable for any claims or damages arising out of products used in applications not expressly intended by Littelfuse as set forth in applicable Littelfuse documentation. The sale and use of Littelfuse products is subject to Littelfuse Terms and Conditions of Sale, unless otherwise agreed by Littelfuse.

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